

# Dense Plasmas in Magnetic Traps: Generation of Focused Ion Beams With Controlled Ion-to-Neutral Flux Ratios

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**Abstract**—Customized magnetic traps were developed to produce a domain of dense plasmas with a narrow ion beam directed to a particular area of the processed substrate. A planar magnetron coupled with an arc discharge source created the magnetic traps to confine the plasma electrons and generate the ion beam with the controlled ratio of ion-to-neutral fluxes. Images of the plasma jet patterns and numerical visualizations help explaining the observed phenomena.

**Index Terms**—Arc discharge, ion beam, magnetic traps.

## I. INTRODUCTION

CONTROL of ion flows to a processed wafer is an important ability of modern nanotechnology based on low-temperature plasma reactors [1]. As shown experimentally, when the substrate is processed by an ion flow in the presence of a neutral component of plasma, the conditions of the surface layer formation strongly depend on the ratio  $\alpha_{in}$  of the ion flow to the neutral flow, thus allowing to obtain qualitatively new characteristics of the surface [2]–[4].

Here, we show that the control of the ion current is possible by combining different plasma sources. Producing a domain

of dense plasmas with a narrow ion beam directed to a particular area of the substrate is obtained in the hybrid plasma setup, which combines the arc and planar magnetron. A photo of the magnetron discharge at the gas pressure of 0.5 Pa is shown in Fig. 1(a). The discharge has a ring structure conditioned by arc-shaped magnetic trap for the electrons. Fig. 1(b) shows the plasma structure produced by the arc source, when the planar magnetron is not operating (i.e., the magnetron discharge was not ignited, but the magnetic field of the magnetron was present). When both sources operate and the magnetic field of the magnetron is directed in-line with the field of the arc source, a bottle configuration of a magnetic trap is formed between the arc source and the substrate. A domain with the excess of the plasma electrons over the ions is generated in the magnetic trap. The ions are affected by a self-consistent electric field, and the plasma flow is focused to a narrow area located right above the magnetic pole of the magnetron, with the ratio  $\alpha_{in}$  of 1. When increasing the gas pressure up to 0.5 Pa, the plasma configuration is changed, as shown in Fig. 1(c), due to the formation of another domain with the electron excess—in the region of the arc-shaped magnetic trap of the magnetron. The domain is formed by the bulk electrons generated due to ionization of the residual gas by the secondary electrons emitted from the substrate. In this case, the ion flow is directed toward the magnetron trap, while  $\alpha_{in} = 0.02$ . At the intermediate pressures, the focusing of the ion flow at a fixed level of the gas pressure is possible. The discharge structure for the pressure of 0.1 Pa ( $\alpha_{in} = 0.1$ ) is shown in Fig. 1(d), schematic of the setup is shown in Fig. 1(e), and the measured distribution of the ion current over the substrate is shown in Fig. 1(f). The  $\alpha_{in}$  parameter was estimated by the technique described in detail in [5].

This technique allows generation of narrow and broad ion beams. In addition, depending on the number and location of the magnetic coils, the ion current density can be varied in  $\sim 2$  times. Our visualizations also reveal the mechanisms of the plasma interaction with the magnetic fields in reactors, thus enabling a further development of plasma-based technologies for deposition, modifications, and growth of nanostructures for microelectronics, optics, energy, and so on.

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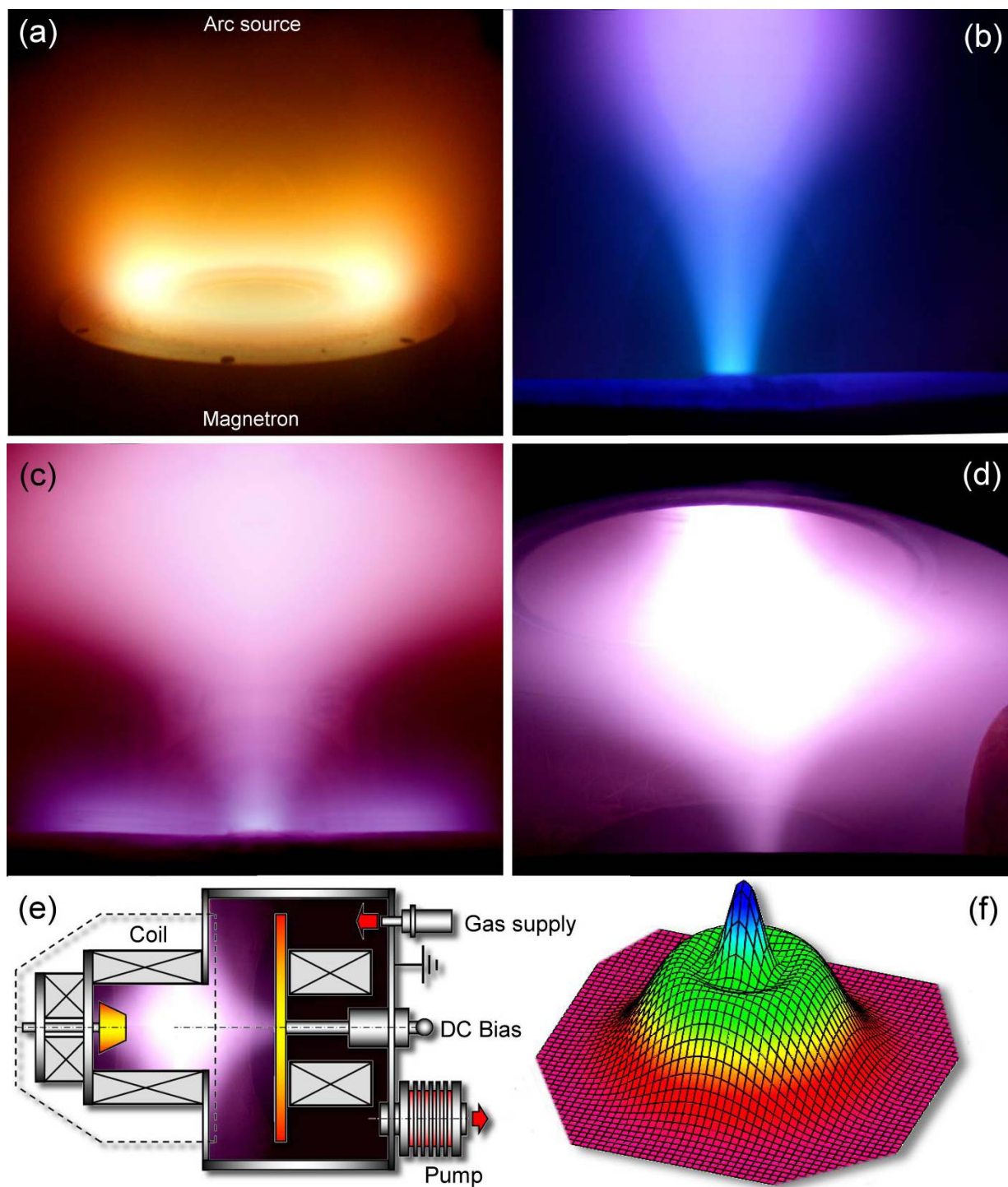


Fig. 1. Plasma patterns for the different configurations of the magnetic traps. (a) Ring-shaped magnetron discharge generated in the arc-shaped magnetic trap. (b) Powerful jet generated by the bottle-shaped magnetic trap between the arc and the magnetron sources at gas pressure of 0.02 Pa. (c) Tube-shaped plasma jet directed from the bottle trap to the arc-shaped trap. (d) Powerful jet with controlled ion-to-neutral fluxes ratio. (e) Schematic of the setup (rotated counterclockwise by  $90^\circ$  relative to the discharge photos). (f) 3-D visualization of the measured distribution of the ion current over the substrate for the configuration in (d).

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